

DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **Methods For Inhibiting Angiogenesis, Cell Migration, Cell Adhesion, And Cell Survival**, the specification of which was filed on **15 December 2004** as Application Serial No. **10/518,181**. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or 365(b) of any foreign application(s) for patent, or inventor's certificate(s), or 365(a) of any PCT international application, which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent, or inventor's certificate, or any PCT international application having a filing date before that of the application on which priority is claimed:

<u>PCT/US2003/020041</u>	<u>PCT</u>	<u>25 June 2003</u>	<u>Yes</u>
<i>Number</i>	<i>Country</i>	<i>Day/Month/Year Filed</i>	<i>Priority Claimed</i>

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States application(s) listed below and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a), which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

<u>60/391,484</u>	<u>25 June 2002</u>	<u>Abandoned</u>
<i>Application Serial No.</i>	<i>Filing Date</i>	<i>Patented, Pending or Abandoned</i>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor: **Judith A. Varner**

Inventor's Signature: <u>Judith A. Varner</u>	Date: <u>7/25/05</u>
Residence: <u>3277 Lone Hill Lane, Encinitas, California 92037</u>	Citizenship: <u>United States of America</u>
Post Office Address: <u>same as above</u>	

Full Name of Second Joint Inventor: **Manjiri Bakre**

Inventor's Signature: _____	Date: _____
Residence: <u>3967 C Miramar Street, La Jolla, California 92038</u>	Citizenship: <u>United States of America</u>
Post Office Address: <u>same as above</u> bakre@p.is.a-star.edu.sg (Singapore)	<u>India</u>

Full Name of Second Joint Inventor: **Hui Jin**

Inventor's Signature: _____	Date: _____
Residence: <u>3365 Lebon Drive #202, San Diego, California 92122</u>	Citizenship: <u>United States of America</u>
Post Office Address: <u>same as above</u> 384 Sedgewood Lane Ann Arbor, MI 48103	<u>Peoples Republic of China</u>

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Full Name of Sole or First Inventor: **Judith A. Varner**

Inventor's Signature: _____	Date: _____
Residence: <u>3277 Lone Hill Lane, Encinitas, California 92024</u>	Citizenship: <u>United States of America</u>
Post Office Address: <u>same as above</u>	

Full Name of Second Joint Inventor: **Manjiri Bakre**

Inventor's Signature: <u></u>	Date: <u>5th Aug 2005</u>
Residence: <u>113, Clementi Rd., Block D, Apt. #10-03, Singapore 129793</u>	Citizenship: <u>India</u>
Post Office Address: <u>same as above</u>	

Full Name of Second Joint Inventor: **Hui Jin**

Inventor's Signature: _____	Date: _____
Residence: <u>384 Sedgewood Lane, Ann Arbor, Michigan 48103</u>	Citizenship: <u>People's Republic of China</u>
Post Office Address: <u>same as above</u>	

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Full Name of Second Joint Inventor: **Manjiri Bakre**

Inventor's Signature: _____	Date: _____
Residence: <u>113, Clementi Rd., Block D, Apt. #10-03, Singapore 129793</u>	Citizenship: <u>India</u>
Post Office Address: <u>same as above</u>	

Full Name of Second Joint Inventor: **Hui Jin**

Inventor's Signature: <u></u>	Date: <u>8/24/05</u>
Residence: <u>384 Sedgewood Lane, Ann Arbor Michigan 48103</u>	Citizenship: <u>People's Republic of China</u>
Post Office Address: <u>same as above</u>	